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<u>MOSFET</u> - Power, DUAL COOL[®] N-Channel, PQFN8 150 V, 11.4 mΩ, 80 A NTMFSC012N15MC

Features

- Advanced Dual-sided Cooled Packaging
- Ulra Low R_{DS(on)}
- MSL1 Robust Packaging Design

Typical Applications

- Primary DC-DC FET
- Synchronous Rectifier
- DC-DC Conversion

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	150	V		
Gate-to-Source Voltage	e		V _{GS}	±20	V	
Continuous Drain Cur-	Steady State	$T_{C} = 25^{\circ}C$	I _D	80	А	
rent $R_{\theta JC}$ (Notes 1, 3)		$T_{C} = 100^{\circ}C$		50		
Power Dissipation		$T_{C} = 25^{\circ}C$	PD	147	W	
R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$		58		
Continuous Drain Current R _{θJA} (Notes 1, 2, 3)	Steady State	$T_A = 25^{\circ}C$	۱ _D	10	А	
		$T_A = 100^{\circ}C$		6		
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)			T _A = 25°C	PD	2.7	W
		$T_A = 100^{\circ}C$		1		
Pulsed Drain Current	T _C = 25	°C, t _p = 10 μs	I _{DM}	1067	А	
Operating Junction / Storage Temperature Max		T _J , T _{stg}	+150	°C		
Source Current (Body Diode)		I _S	122	А		
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 35 A)		E _{AS}	161	mJ		
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)		ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.85	°C/W
Junction-to-Case Top - Steady State	$R_{\theta JT}$	1.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	46	

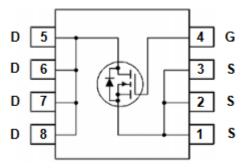
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

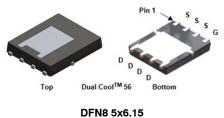
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
150 V	11.4 m Ω @ 10 V	44 A
150 V	14.5 mΩ @ 8 V	22 A

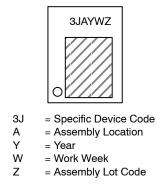
N-CHANNEL MOSFET





CASE 506EG

MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFSC012N15MC	PQFN8 (Pb-Free)	3000 / Tape & Reel

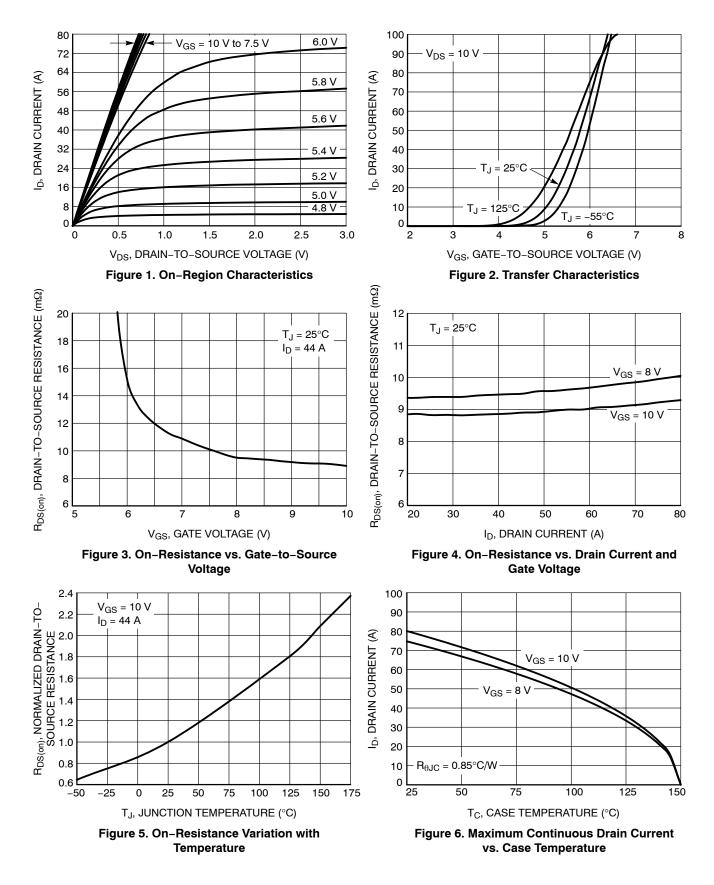
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

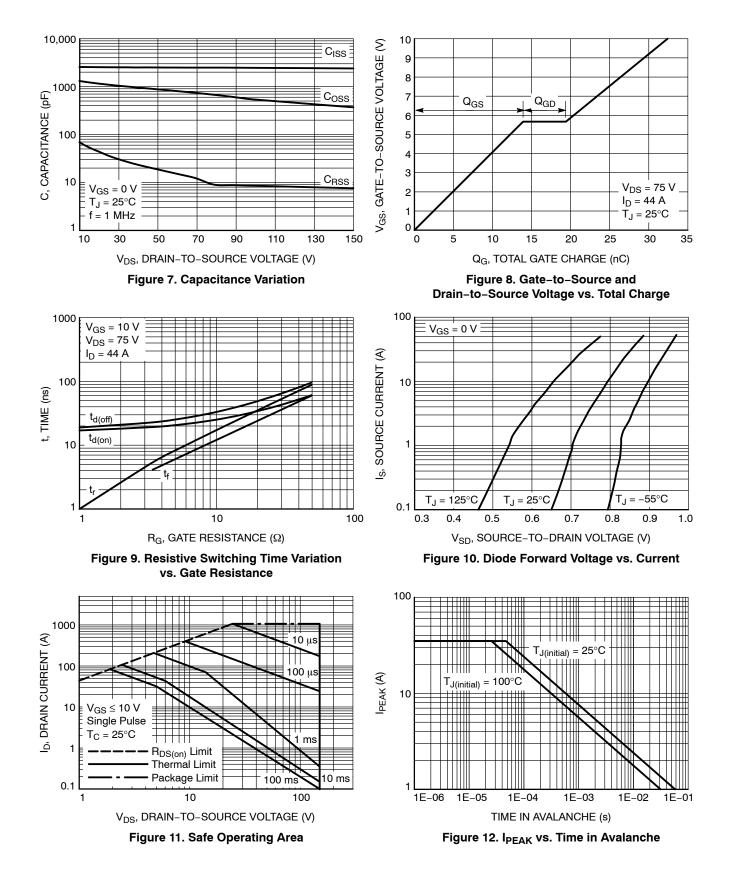
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		150			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	I_D = 250 µA, ref to 25°C			6.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1	μA
		V _{DS} = 150 V	T _J = 125°C			100	-
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$: 194 μA	2.5		4.5	V
Negative Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$	I _D = 194 μA, ref	to 25°C		8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 44 A		8.9	11.4	mΩ
		V _{GS} = 8 V	I _D = 22 A		9.5	14.5	
Gate-Resistance	R _G	T _A = 25°C			0.7		Ω
CHARGES & CAPACITANCES							
Input Capacitance	C _{ISS}	$V_{GS} = 0 V, f = 1 MHz, V_{DS} = 75 V$ $V_{GS} = 6 V, V_{DS} = 75 V, I_D = 44 A$			2490		pF
Output Capacitance	C _{OSS}				676		
Reverse Transfer Capacitance	C _{RSS}				9.0		
Total Gate Charge	Q _{G(TOT)}				20.4		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 75 V, I_{D} = 44 A			32.4		
Gate-to-Source Charge	Q _{GS}				13.9		
Gate-to-Drain Charge	Q _{GD}				5.5		
Plateau Voltage	V _{GP}				5.7		V
SWITCHING CHARACTERISTICS (Note 4)					-	-	
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 75 V, I_{D} = 44 A, R_{G} = 2.5 Ω			18.4		ns
Rise Time	t _r				3.7		
Turn–Off Delay Time	t _{d(OFF)}				21.3		
Fall Time	t _f				3		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S	-		-	-	•	-
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 44 A	$T_J = 25^{\circ}C$		0.88		V
			T _J = 125°C		0.76		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 1000 A/μs,			42.7		ns
Reverse Recovery Charge	Q _{RR}	I _S = 44 A	A		559		nC
	SHR	<u> </u>			000		Ļ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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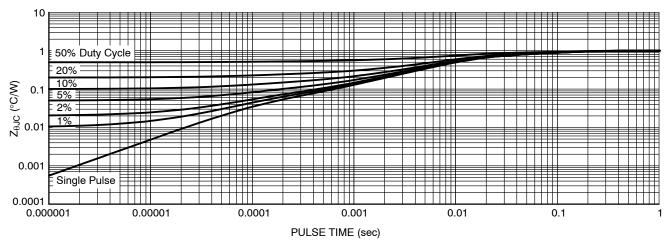
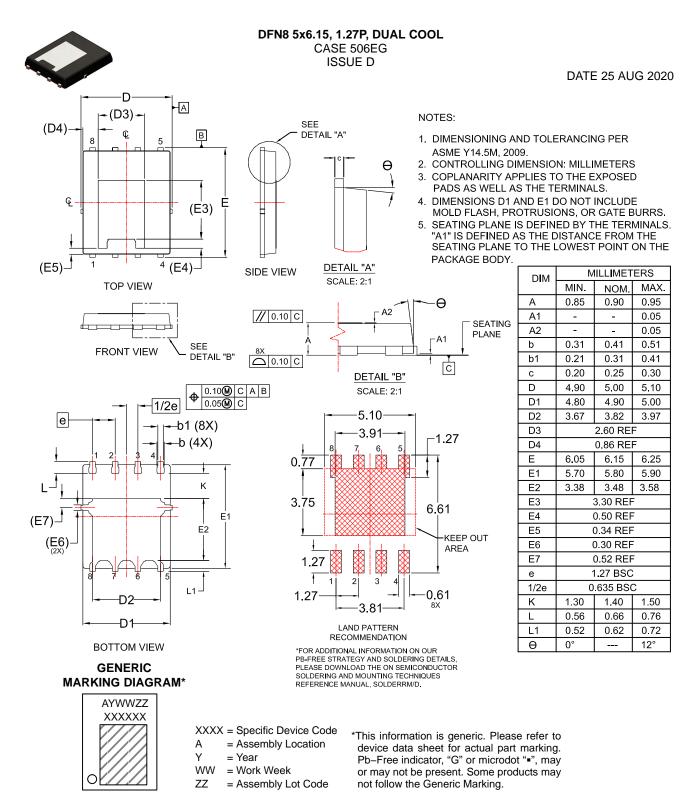


Figure 13. Thermal Characteristics

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